

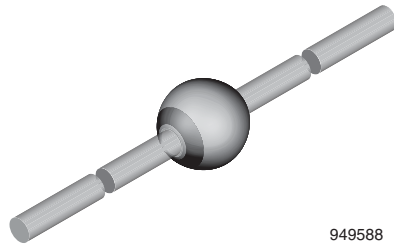


THE DATASHEET OF SF5400-TAP





Ultra-Fast Avalanche Sinterglass Diode



949588

DESIGN SUPPORT TOOLS

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FEATURES

- Glass passivated
- Hermetically sealed axial leaded glass envelope
- Low reverse current
- High reverse voltage
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Switched mode power supplies
- High-frequency inverter circuits

MECHANICAL DATA

Case: SOD-64

Terminals: plated axial leads, solderable per MIL-STD-750, method 2026

Polarity: color band denotes cathode end

Mounting position: any

Weight: approx. 858 mg

ORDERING INFORMATION (Example)			
DEVICE NAME	ORDERING CODE	TAPED UNITS	MINIMUM ORDER QUANTITY
SF5408	SF5408-TR	2500 per 10" tape and reel	12 500
SF5408	SF5408-TAP	2500 per ammpack	12 500

PARTS TABLE		
PART	TYPE DIFFERENTIATION	PACKAGE
SF5400	$V_R = 50\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5401	$V_R = 100\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5402	$V_R = 200\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5403	$V_R = 300\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5404	$V_R = 400\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5405	$V_R = 500\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5406	$V_R = 600\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5407	$V_R = 800\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64
SF5408	$V_R = 1000\text{ V}; I_{F(AV)} = 3\text{ A}$	SOD-64



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Reverse voltage = repetitive peak reverse voltage	See electrical characteristics	SF5400	V _R = V _{RRM}	50	V
		SF5401	V _R = V _{RRM}	100	V
		SF5402	V _R = V _{RRM}	200	V
		SF5403	V _R = V _{RRM}	300	V
		SF5404	V _R = V _{RRM}	400	V
		SF5405	V _R = V _{RRM}	500	V
		SF5406	V _R = V _{RRM}	600	V
		SF5407	V _R = V _{RRM}	800	V
		SF5408	V _R = V _{RRM}	1000	V
Peak forward surge current	t _p = 2 ms, half sine wave		I _{FSM}	150	A
	t _p = 10 ms, half sine wave			80	
Average forward current			I _{F(AV)}	3	A
Junction and storage temperature range			T _j = T _{stg}	-55 to +175	°C
Non repetitive reverse avalanche energy	I _{(BR)R} = 0.4 A		E _R	10	mJ

MAXIMUM THERMAL RESISTANCE (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction ambient	Lead length l = 10 mm, T _L = constant	R _{thJA}	25	K/W
	On PC board with spacing 25 mm	R _{thJA}	70	K/W

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 3 A	SF5400	V _F	-	-	1.1	V
		SF5401	V _F	-	-	1.1	V
		SF5402	V _F	-	-	1.1	V
		SF5403	V _F	-	-	1.1	V
		SF5404	V _F	-	-	1.1	V
		SF5405	V _F	-	-	1.7	V
		SF5406	V _F	-	-	1.7	V
		SF5407	V _F	-	-	1.7	V
		SF5408	V _F	-	-	1.7	V
Reverse current	V _R = V _{RRM}		I _R	-	-	5	μA
	V _R = V _{RRM} , T _j = 125 °C		I _R	-	-	50	μA
Reverse breakdown voltage	I _R = 100 μA	SF5400	V _{(BR)R}	60	-	-	V
		SF5401	V _{(BR)R}	110	-	-	V
		SF5402	V _{(BR)R}	220	-	-	V
		SF5403	V _{(BR)R}	330	-	-	V
		SF5404	V _{(BR)R}	440	-	-	V
		SF5405	V _{(BR)R}	550	-	-	V
		SF5406	V _{(BR)R}	660	-	-	V
		SF5407	V _{(BR)R}	880	-	-	V
		SF5408	V _{(BR)R}	1100	-	-	V
Reverse recovery time	I _F = 0.5 A, I _R = 1 A, i _R = 0.25 A	SF5400	t _{rr}	-	-	50	ns
		SF5401	t _{rr}	-	-	50	ns
		SF5402	t _{rr}	-	-	50	ns
		SF5403	t _{rr}	-	-	50	ns
		SF5404	t _{rr}	-	-	50	ns
		SF5405	t _{rr}	-	-	75	ns
		SF5406	t _{rr}	-	-	75	ns
		SF5407	t _{rr}	-	-	75	ns
		SF5408	t _{rr}	-	-	75	ns



TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

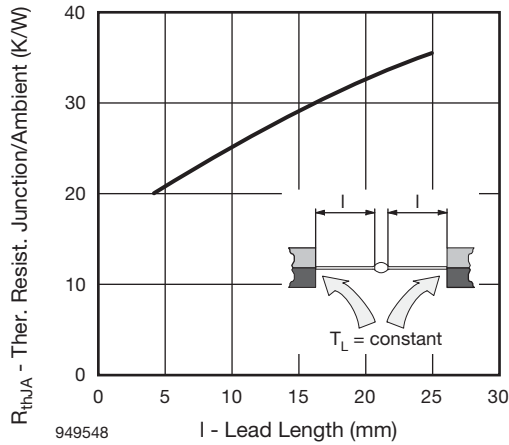


Fig. 1 - Max. Thermal Resistance vs. Lead Length

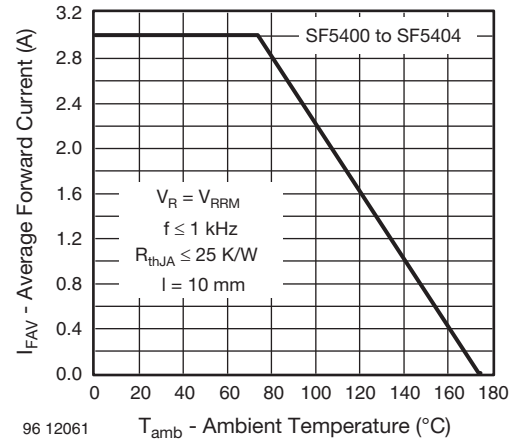


Fig. 4 - Max. Average Forward Current vs. Ambient Temperature

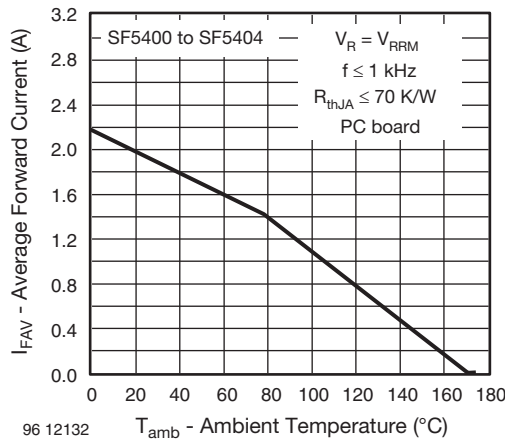


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

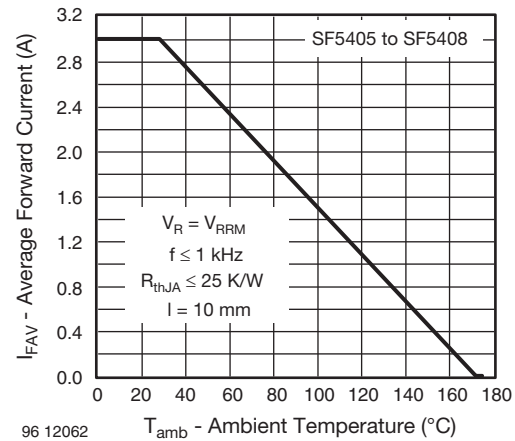


Fig. 5 - Max. Average Forward Current vs. Ambient Temperature

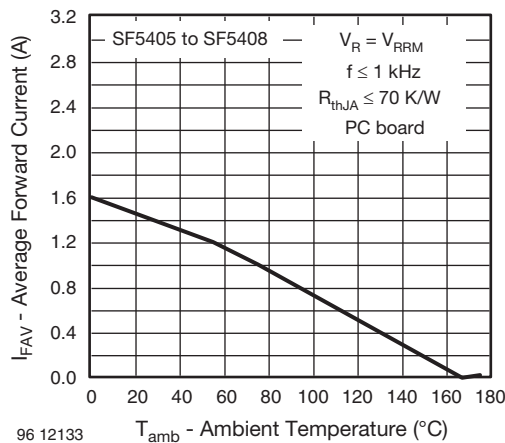


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

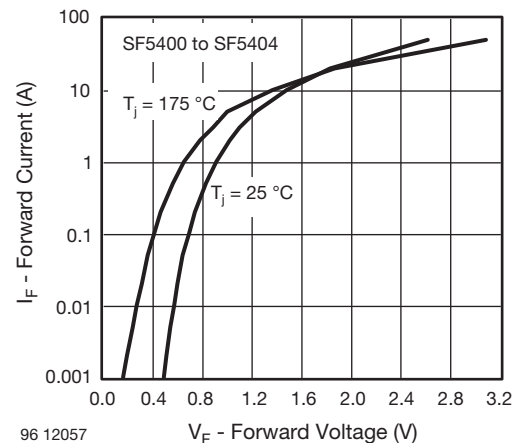


Fig. 6 - Max. Forward Current vs. Forward Voltage

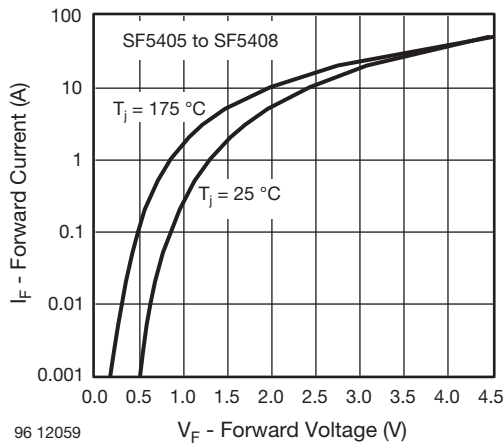


Fig. 7 - Max. Forward Current vs. Forward Voltage

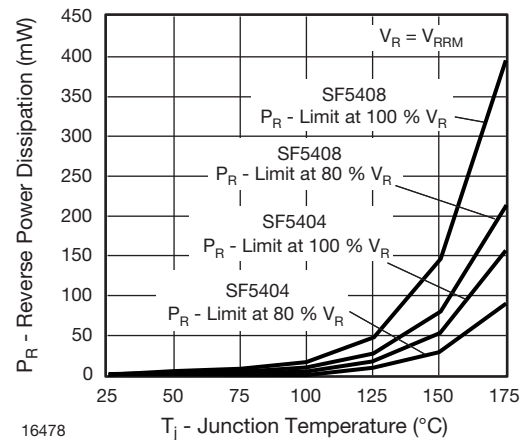


Fig. 9 - Max. Reverse Power Dissipation vs. Junction Temperature

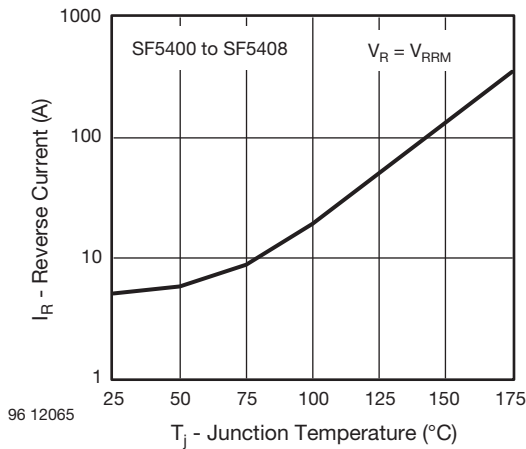


Fig. 8 - Max. Reverse Current vs. Junction Temperature

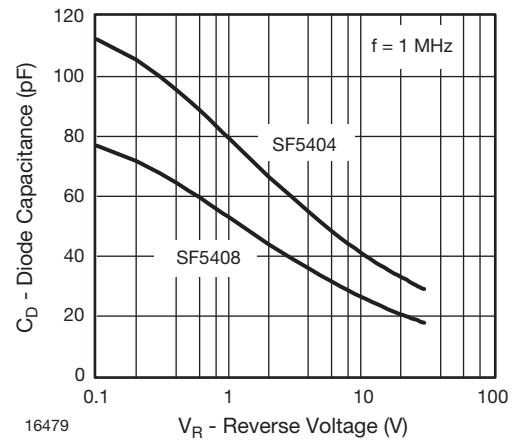
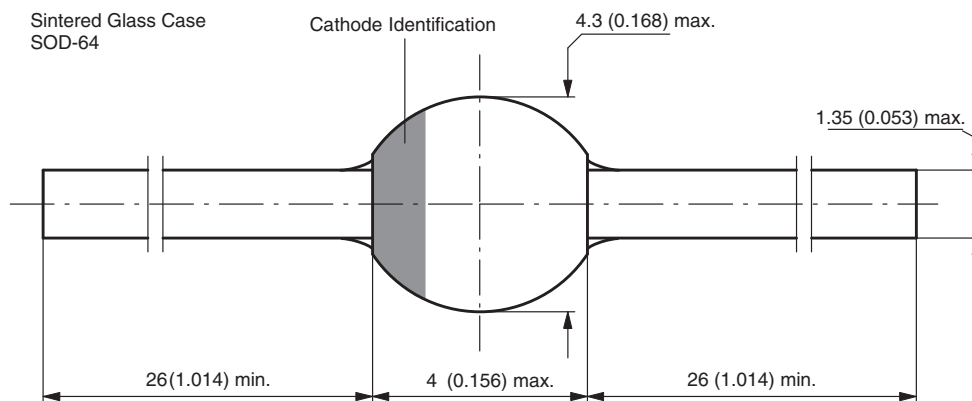


Fig. 10 - Diode Capacitance vs. Reverse Voltage

PACKAGE DIMENSIONS in millimeters (inches): **SOD-64**



Document-No.: 6.563-5006.4-4
Rev. 3 - Date: 09.February.2005
94 9587



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